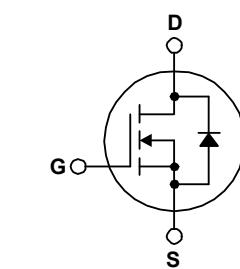
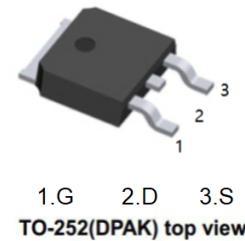


## Description

This N-Channel enhancement mode power MOSFET is planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.



## Features

- $V_{DS} = 100V$
- $R_{DS(ON)}$  (at  $V_{GS}=10V$ ) <  $350m\Omega$
- $I_D$  (at  $V_{GS}=10V$ )  $2.9A$
- Low Gate Charge (Typ. 4.6 nC)
- Low Crss (Typ. 12 pF)

## Absolute Maximum Ratings

$T_C = 25^\circ C$  unless otherwise noted.

Symbol	Parameter	FQD7N10LTM	Unit
$V_{DSS}$	Drain-Source Voltage	100	V
$I_D$	Drain Current - Continuous ( $T_C = 25^\circ C$ )	5.8	A
	- Continuous ( $T_C = 100^\circ C$ )	3.67	A
$I_{DM}$	Drain Current - Pulsed	(Note 1)	A
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	V
$E_{AS}$	Single Pulsed Avalanche Energy	(Note 2)	mJ
$I_{AR}$	Avalanche Current	(Note 1)	A
$E_{AR}$	Repetitive Avalanche Energy	(Note 1)	mJ
$dv/dt$	Peak Diode Recovery $dv/dt$	(Note 3)	V/ns
$P_D$	Power Dissipation ( $T_A = 25^\circ C$ ) *	2.5	W
	Power Dissipation ( $T_C = 25^\circ C$ )	25	W
	- Derate above $25^\circ C$	0.2	W/ $^\circ C$
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	$^\circ C$
$T_L$	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	$^\circ C$

## Thermal Characteristics

Symbol	Parameter	FQD7N10LTM	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	5.0	$^\circ C/W$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	110	
	Thermal Resistance, Junction to Ambient (*1 in <sup>2</sup> Pad of 2-oz Copper), Max.	50	

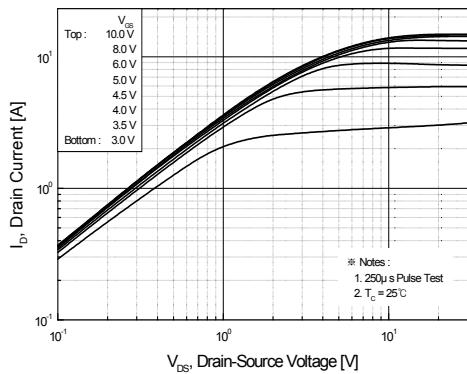
### Electrical Characteristics $T_c = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}$ , $I_D = 250 \mu\text{A}$	100			V
$\Delta \text{BV}_{\text{DSS}} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$ , Referenced to $25^\circ\text{C}$		0.1		$\text{V}/^\circ\text{C}$
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 100 \text{ V}$ , $V_{\text{GS}} = 0 \text{ V}$		1		$\mu\text{A}$
		$V_{\text{DS}} = 80 \text{ V}$ , $T_c = 125^\circ\text{C}$		10		$\mu\text{A}$
$I_{\text{GSSF}}$	Gate-Body Leakage Current, Forward	$V_{\text{GS}} = 20 \text{ V}$ , $V_{\text{DS}} = 0 \text{ V}$		100		nA
$I_{\text{GSSR}}$	Gate-Body Leakage Current, Reverse	$V_{\text{GS}} = -20 \text{ V}$ , $V_{\text{DS}} = 0 \text{ V}$		-100		nA
<b>On Characteristics</b>						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}$ , $I_D = 250 \mu\text{A}$	1.0		2.0	V
$R_{\text{DS(on)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}} = 10 \text{ V}$ , $I_D = 2.9 \text{ A}$		275	350	$\text{m } \Omega$
		$V_{\text{GS}} = 5 \text{ V}$ , $I_D = 2.9 \text{ A}$	300	380		
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}} = 30 \text{ V}$ , $I_D = 2.9 \text{ A}$		4.6		S
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}} = 25 \text{ V}$ , $V_{\text{GS}} = 0 \text{ V}$ , $f = 1.0 \text{ MHz}$		220	290	pF
$C_{\text{oss}}$	Output Capacitance			55	72	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance			12	15	pF
<b>Switching Characteristics</b>						
$t_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DD}} = 50 \text{ V}$ , $I_D = 7.3 \text{ A}$ , $R_G = 25 \Omega$		9	30	ns
$t_r$	Turn-On Rise Time			100	210	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time			17	45	ns
$t_f$	Turn-Off Fall Time		(Note 4)	50	110	ns
$Q_g$	Total Gate Charge	$V_{\text{DS}} = 80 \text{ V}$ , $I_D = 7.3 \text{ A}$ , $V_{\text{GS}} = 5 \text{ V}$		4.6	6.0	nC
$Q_{\text{gs}}$	Gate-Source Charge			1.0		nC
$Q_{\text{gd}}$	Gate-Drain Charge		(Note 4)	2.6		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_S$	Maximum Continuous Drain-Source Diode Forward Current			5.8		A
$I_{\text{SM}}$	Maximum Pulsed Drain-Source Diode Forward Current			23.2		A
$V_{\text{SD}}$	Drain-Source Diode Forward Voltage	$V_{\text{GS}} = 0 \text{ V}$ , $I_S = 5.8 \text{ A}$		1.5		V
$t_{\text{rr}}$	Reverse Recovery Time	$V_{\text{GS}} = 0 \text{ V}$ , $I_S = 7.3 \text{ A}$ , $dI_F / dt = 100 \text{ A}/\mu\text{s}$		70		ns
$Q_{\text{rr}}$	Reverse Recovery Charge			140		nC

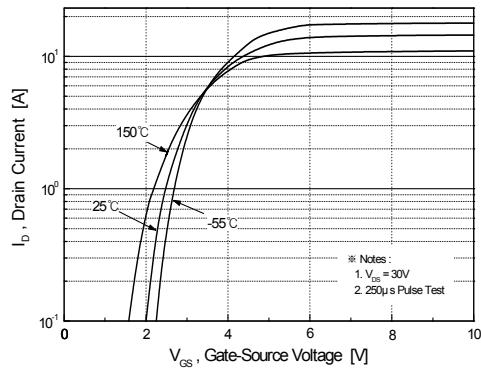
**Notes:**

1. Repetitive rating : pulse-width limited by maximum junction temperature.
2.  $L = 2.23 \text{ mH}$ ,  $I_{AS} = 5.8 \text{ A}$ ,  $V_{DD} = 25 \text{ V}$ ,  $R_G = 25 \Omega$ , starting  $T_J = 25^\circ\text{C}$ .
3.  $I_{SD} \leq 7.3 \text{ A}$ ,  $dI/dt \leq 300 \text{ A}/\mu\text{s}$ ,  $V_{DD} \leq \text{BV}_{\text{DSS}}$ , starting  $T_J = 25^\circ\text{C}$ .
4. Essentially independent of operating temperature.

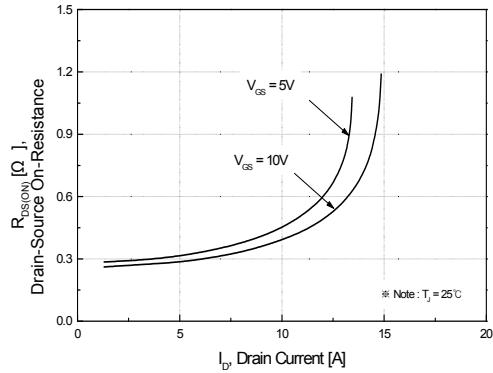
## Typical Characteristics



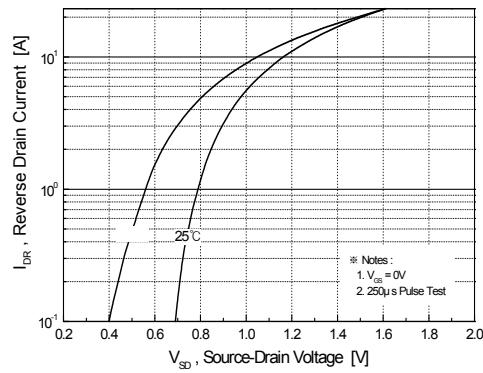
**Figure 1. On-Region Characteristics**



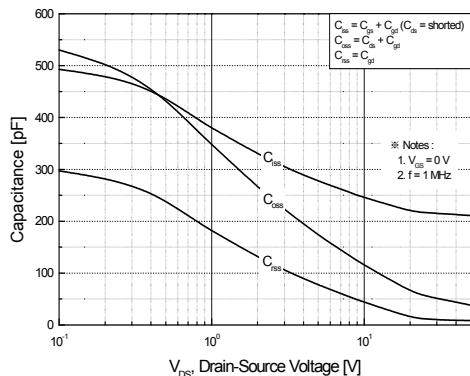
**Figure 2. Transfer Characteristics**



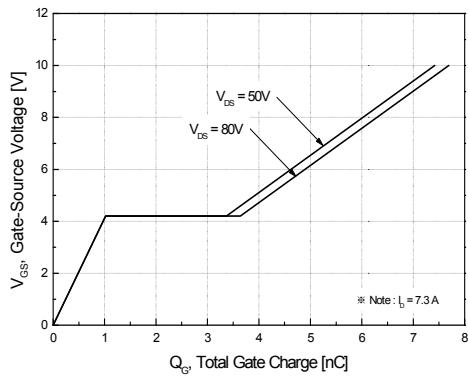
**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**



**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**

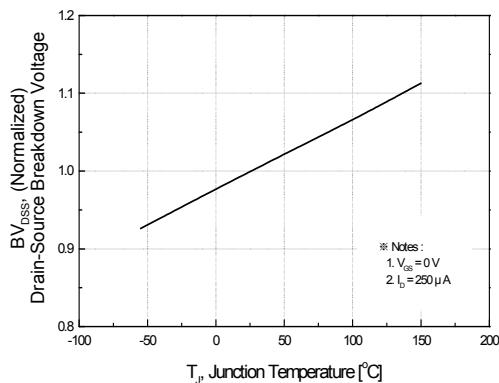


**Figure 5. Capacitance Characteristics**

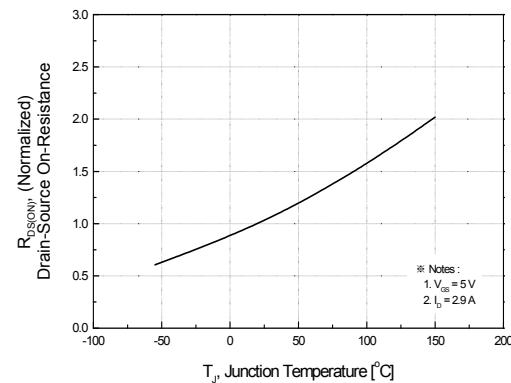


**Figure 6. Gate Charge Characteristics**

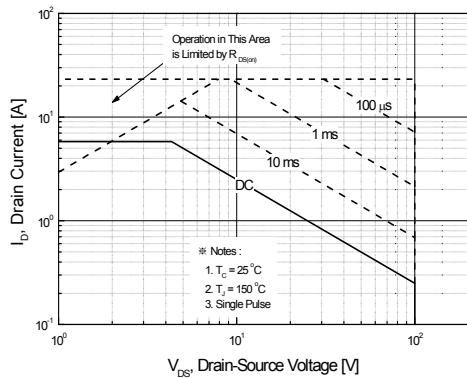
## Typical Characteristics



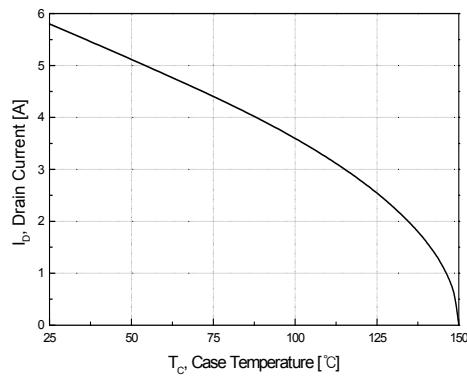
**Figure 7. Breakdown Voltage Variation vs. Temperature**



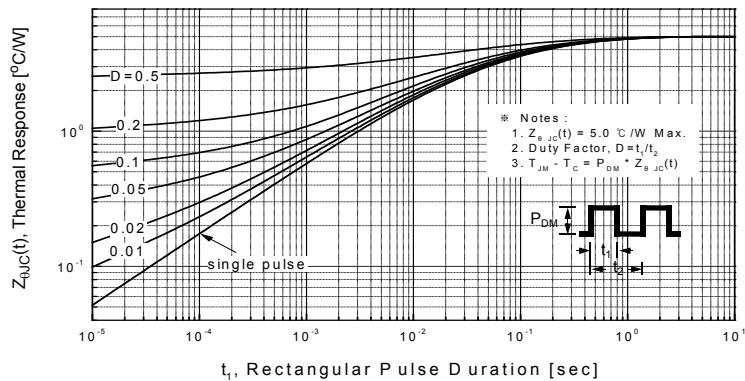
**Figure 8. On-Resistance Variation vs. Temperature**



**Figure 9. Maximum Safe Operating Area**



**Figure 10. Maximum Drain Current vs. Case Temperature**



**Figure 11. Transient Thermal Response Curve**

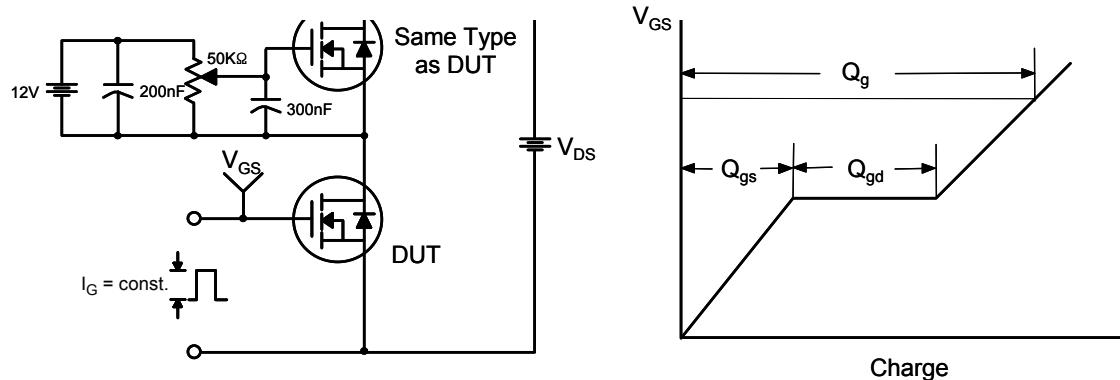


Figure 12. Gate Charge Test Circuit & Waveform

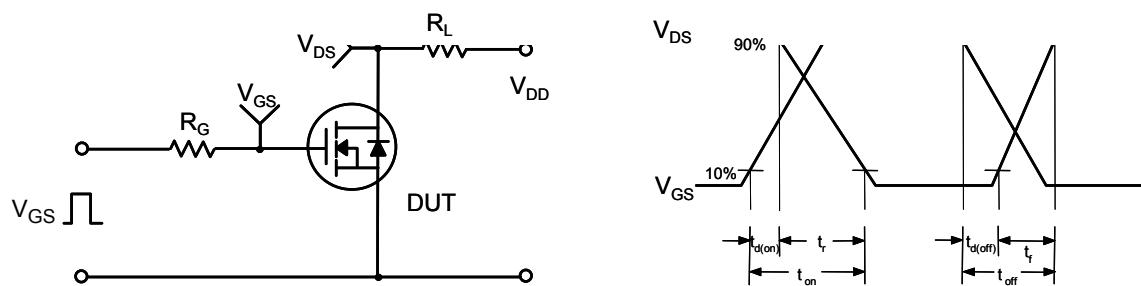


Figure 13. Resistive Switching Test Circuit & Waveforms

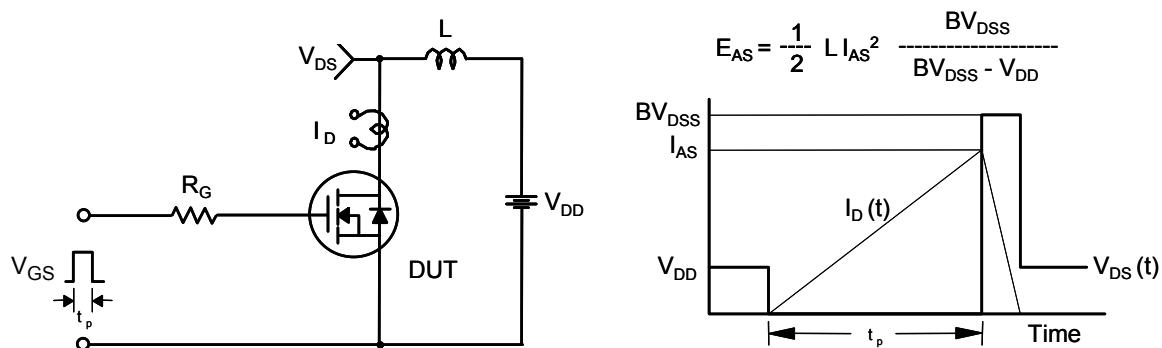
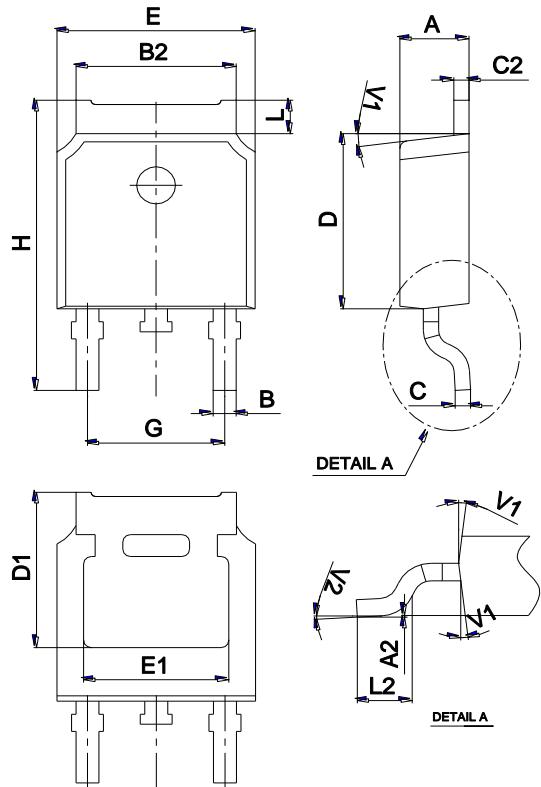


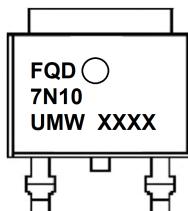
Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

## Package Mechanical Data TO-252



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
B	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
H	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

## Marking



## Ordering information

Order code	Package	Baseqty	Deliverymode
UMW FQD7N10LTM	TO-252	2500	Tape and reel